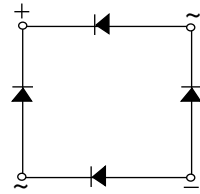
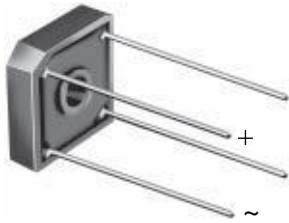




## Glass Passivated Single-Phase Bridge Rectifier



Case Style GBPC6

### FEATURES

- UL recognition file number E54214
- Ideal for printed circuit boards
- Typical  $I_R$  less than 0.5  $\mu A$
- High surge current capability
- High case dielectric strength 1500  $V_{RMS}$
- Solder dip 275 °C max. 10 s, per JESD 22-B106
- Material categorization: For definitions of compliance please see [www.vishay.com/doc?99912](http://www.vishay.com/doc?99912)



RoHS  
COMPLIANT

PRIMARY CHARACTERISTICS	
Package	GBPC6
$I_{F(AV)}$	6 A
$V_{RRM}$	50 V, 100 V, 200 V, 400 V, 600 V, 800 V, 1000 V
$I_{FSM}$	175 A
$I_R$	5 $\mu A$
$V_F$ at $I_F = 3.0 A$	1.0 V
$T_J$ max.	150 °C
Diode variations	Quad

### TYPICAL APPLICATIONS

General purpose use in AC/DC bridge full wave rectification for power supply, home appliances, office equipment, industrial automation applications.

### MECHANICAL DATA

**Case:** GBPC6

Molding compound meets UL 94 V-0 flammability rating Base P/N-E4 - RoHS-compliant, commercial grade

**Terminals:** Silver plated leads, solderable per J-STD-002 and JESD22-B102

**Polarity:** As marked, positive lead by beveled corner

**Mounting Torque:** 10 cm-kg (8.8 in-lbs) maximum

**Recommended Torque:** 5.7 cm-kg (5 in-lbs) maximum

MAXIMUM RATINGS ( $T_A = 25\text{ °C}$ unless otherwise noted)										
PARAMETER	SYMBOL	GBPC 6005	GBPC 601	GBPC 602	GBPC 604	GBPC 606	GBPC 608	GBPC 610	UNIT	
Maximum repetitive peak reverse voltage	$V_{RRM}$	50	100	200	400	600	800	1000	V	
Maximum RMS bridge input voltage	$V_{RMS}$	35	70	140	280	420	560	700	V	
Maximum DC blocking voltage	$V_{DC}$	50	100	200	400	600	800	1000	V	
Maximum average forward rectified output current at	$I_{F(AV)}$	$T_C = 50\text{ °C}$ (1)(2)							6.0	A
		$T_A = 40\text{ °C}$ (3)							3.0	
Peak forward surge current single sine-wave superimposed on rated load	$I_{FSM}$	175							A	
Rating for fusing ( $t = 8.3\text{ ms}$ )	$I^2t$	127							A <sup>2</sup> s	
Operating junction and storage temperature range	$T_J, T_{STG}$	- 55 to + 150							°C	

### Notes

- (1) Bolt down on heat-sink with silicone thermal compound between bridge and mounting surface for maximum heat transfer with #6 screw
- (2) Unit mounted on 5.5" x 6.0" x 0.11" thick (14 cm x 15 cm x 0.3 cm) aluminum plate
- (3) Unit mounted on PCB at 0.375" (9.5 mm) lead length with 0.5" x 0.5" (12 mm x 12 mm) copper pads



ELECTRICAL CHARACTERISTICS (T <sub>A</sub> = 25 °C unless otherwise noted)											
PARAMETER	SYMBOL	TEST CONDITIONS	GBPC 6005	GBPC 601	GBPC 602	GBPC 604	GBPC 606	GBPC 608	GBPC 610	UNIT	
Maximum instantaneous forward voltage drop per diode	V <sub>F</sub>	3.0 A	1.0								V
Maximum DC reverse current at rated DC blocking voltage per diode	I <sub>R</sub>	T <sub>A</sub> = 25 °C	5.0								μA
		T <sub>A</sub> = 125 °C	500								
Typical junction capacitance per diode	C <sub>J</sub>	4.0 V, 1 MHz	186				90				pF

THERMAL CHARACTERISTICS (T <sub>A</sub> = 25 °C unless otherwise noted)										
PARAMETER	SYMBOL	GBPC 6005	GBPC 601	GBPC 602	GBPC 604	GBPC 606	GBPC 608	GBPC 610	UNIT	
Typical thermal resistance (1)	R <sub>θJA</sub>	22								°C/W
	R <sub>θJC</sub>	7.3								

**Notes**

- (1) Bolt down on heat-sink with silicone thermal compound between bridge and mounting surface for maximum heat transfer with #6 screw
- (2) Unit mounted on 5.5" x 6.0" x 0.11" thick (14 cm x 15 cm x 0.3 cm) aluminum plate
- (3) Unit mounted on PCB at 0.375" (9.5 mm) lead length with 0.5" x 0.5" (12 mm x 12 mm) copper pads

ORDERING INFORMATION (Example)				
PREFERRED P/N	UNIT WEIGHT (g)	PACKAGE CODE	BASE QUANTITY	DELIVERY MODE
GBPC606-E4/51	3.2	51	100	Paper box

**RATINGS AND CHARACTERISTICS CURVES (T<sub>A</sub> = 25 °C unless otherwise noted)**

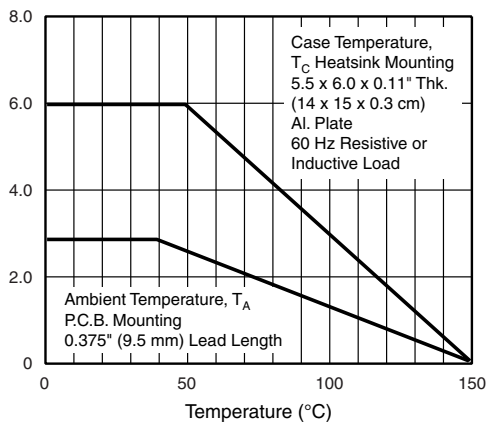


Fig. 1 - Derating Curve Output Rectified Current

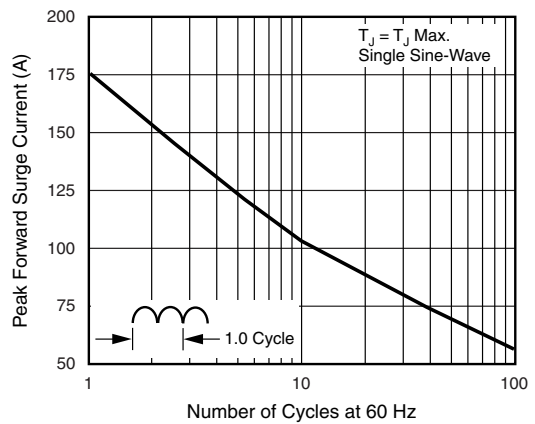


Fig. 2 - Maximum Non-Repetitive Peak Forward Surge Current Per Diode

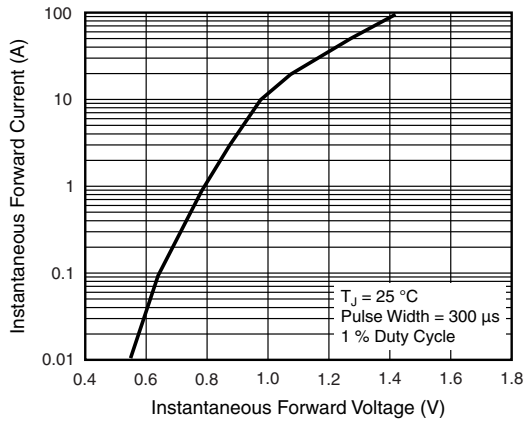


Fig. 3 - Typical Forward Characteristics Per Diode

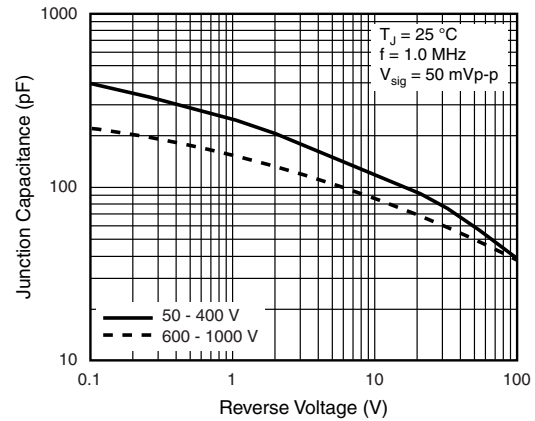


Fig. 5 - Typical Junction Capacitance Per Diode

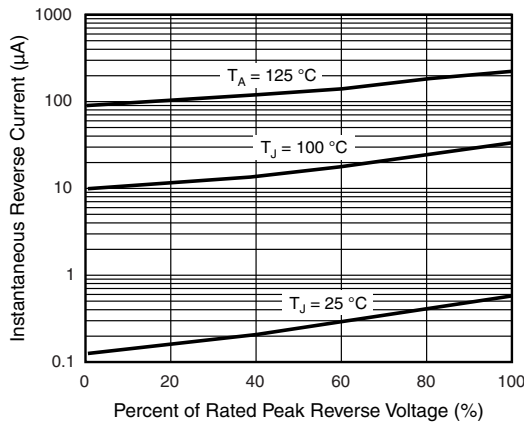


Fig. 4 - Typical Reverse Leakage Characteristics Per Diode

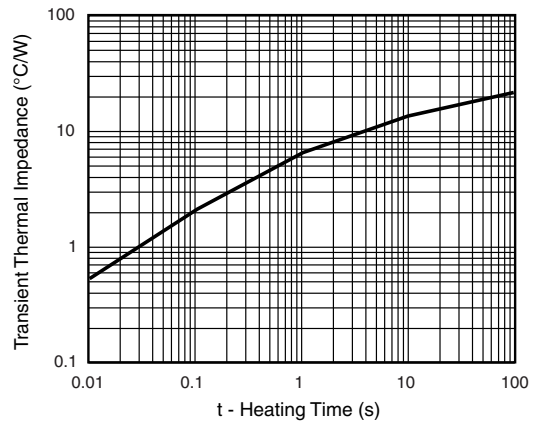
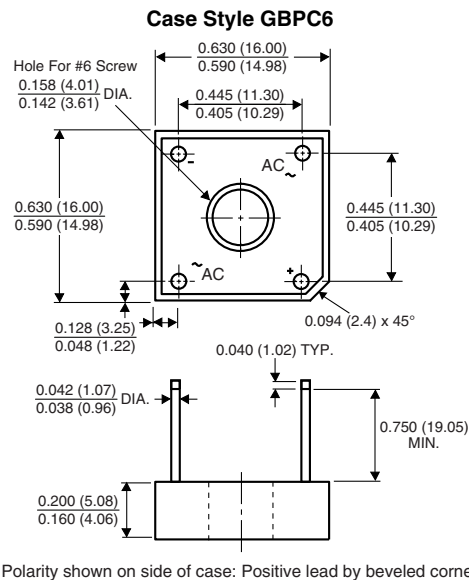


Fig. 6 - Typical Transient Thermal Impedance Per Diode

**PACKAGE OUTLINE DIMENSIONS** in inches (millimeters)





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